Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	8225	semiconductor near module$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45
L2	90473	semiconductor and module$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45
L3	17	1 and (((power near switch$3) MIS) with (IC (intergrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:51
L4	171	2 and (((power near switch$3) MIS) with (IC (intergrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:50
L5	308	2 and (((power near switch$3) MIS) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:53
L6	20	1 and (((power near switch$3) MIS) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:17
L7	2	5 and (flip near chip near bond$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:16
L8	28	("2577584" | "3716764" | "4045867" | "4067951" | "4126292" | "4569814" | "4689103" | "4900501" | "4946633" | "4979289" | "5052907" | "5071612" | "5175007" | "5239198" | "5468999" | "5474958" | "5542171" | "5556647" | "5578261" | "5624691" | "5674785" | "5682673" | "5741530" | "5744083" | "5744084" | "5804467").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 13:54

L9	26	("4199777" | "4483067" | "4505799" | "4899107" | "4954458" | "4992849" | "4992850" | "5022580" | "5041396" | "5063177" | "5068205" | "5075253" | "5138434" | "5155067" | "5188984" | "5200363" | "5239198" | "5326428" | "5346859" | "5346861" | "5419807" | "5426072" | "5468999" | "5474957" | "5536685" | "5545291").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 14:12
L10	2590	(power near (MOS MIS switch$3)) with (IC (integrated near circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:54
L11	239	10 and ((thermal heat) near (dissipat$3 sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:56
L12	98	11 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:56
L13	7286	(flip near chip near bond$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:16
L14	0	13 and ((power near (MOS MIS)) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:20
L15	0	13 and ((power near (MOS MIS)) near (die chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:19
L16	6	13 and ((power near (MOSFET MIS)) near (die chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:19

L17	43	13 and ((power near (die chip)) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:33
L18	186	13 and (power near (die$1 chip$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:33
S1	16855	257/778,81,99,177-181,584,625,675,688, 689,705-707,712-722,796.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:50
S2	2	S1 and ((power near switch$3) with (driv$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:46
S3	4	("5109318" | "5373418" | "5375040" | "5514917").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 18:46
S4	849	S1 and (flip near chip near bond$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:52
S5	80	S4 and (power near (device$1 chip$1 IC circuit$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:00
S6	234	S4 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:54
S7	22	S6 and (resin with seal$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:09

S8	734119	"257"/$.ccls. "438"/$.ccls. "361"/$.ccls. "29"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:03
S9	14	S8 and ((power near switch$3) with (driv$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:06
S10	1176	S8 and (DC near DC near converter$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:14
S11	10	S10 and (flip near chip near bond$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:15
S12	205	S10 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S13	14	S12 and (resin with seal$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S14	24000	(DC near DC near converter$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:14
S15	17	S14 and (flip near chip near bond$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:15
S16	674	S14 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16

S17	15	S16 and (resin with seal$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S18	16	("3303265" | "3996603" | "4788626" | "5168344" | "5248901" | "5297001" | "5446314" | "5532513" | "5689089" | "5750926" | "5942796" | "5945735" | "6078501" | "6297549" | "6303974").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:18
S19	8	("4788626" | "5168344" | "5248901" | "5446314" | "5750926" | "5942796" | "5945735" | "6078501").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:20
S20	7	("5315482" | "5557502" | "5631807" | "5701231" | "5710733" | "5712762" | "5847935").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:28
S21	14	S14 and ((power near switch$3) with (driv$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:30
S22	16	S14 and ((power near switch$3) with (driv$3 near (IC (integrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:30
S23	7	("5726869" | "5734563" | "5870299" | "5920473" | "6400579" | "6466458" | "6466462").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:31
S24	4	(("6040626") or ("6396127")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/06/02 08:53
S25	1	10/643717	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:54
S26	2	10/438106	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:58

S27	0	11/022765	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:59
S28	2	"11022765"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:11
S29	93	high near speed near imag$3 near sens$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:31
S30	3819	cmos near imag$3 near sens$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:32
S31	22	S30 and (photo near electric near conversion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45